A model implementation environment to support rapid prototyping of new TCAD models: A case study for dopant diffusion

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September 5, 1997

1 Introduction

The "scripting" of physical models has evolved over the past decade, both for ECAD and TCAD models, from simple parameterization of fixed models towards user-defined models. This white-paper project is exploring the options for a common (and hopefully minimal) diffusion model representation the would allow model developers to script models using a simple language outside and independent of the simulators that execute the models. The common representation would provide for rapid transfer from model developers (i.e. university researchers), who would produce and distribute their models in the format discussed below, to industrial end users, who could immediately apply the model to simulation of dopant profile evolution in a device structure using a conforming TCAD platform.

The primary limiting assumption is to restrict applicability to continuum PDE-based models appropriate for simulation of redistribution of impurities in orientation-independent materials. The intent of this paper is not to propose an environment capable of simulating every "diffusion" mechanism imaginable, but rather to produce a realistic and useful environment for portable diffusion model representation and simulation applicable to bulk processing for silicon technology.

The hierarchy of diffusion models targeted by this representation ranges from the "fermi" model, in which excess point defects are ignored and diffusivities are only functions of the local Fermi-level, through the "fully-coupled" model, in which excess point defects and extended defects are

considered and dopant-defect pairs are considered to be in equilibrium with the local dopant and defect concentrations, to kinetic models, in which the assumption of local equilibrium of pairs is removed and dopant-defect complexes are solved for as independent variables.

These diffusion models can also be influenced by stress and moving interfaces caused by concurrent oxidation or salicidation processes. The equations that are used to model these external processes cannot be represented by the proposed scripting specification discussed in this paper, but the impact of these loosely coupled effects on the diffusion equations can be included in diffusion models by staggering the simulation of the script-based diffusion model with the simulation of the concurrent process via an non-script-based model available in the simulator and the sharing of field data, such as the speed of the moving boundary.

Future revisions of the specification for this environment will likely address issues such as orientation-dependent diffusivity and may even extend the model representation to include PDE representation into the continuum mechanics realm with applicability to oxidation/salicidation as well as thermal stress modeling.

2 Requirements

2.1 User-specified equations

While simulators providing only prepackaged "general" models, such as the fully coupled formulation, may look promising as the foundation for prototyping environment, it is important to note that effects such as TED caused by dissolution of [311] defects, in order to be be predictively modeled, require additional equations. With the traditional approach to implementing process simulators, the discretized equations and intelligence about when to add extra equations/terms is hard-coded in the simulator. Access to and an understanding of the source code would normally be required to prototype a new model. There are quite a few reasons why the implementation approach must be changed. The most significant ones are:

- there is little chance that the commercial TCAD vendors will publicly release their source code and permit redistribution of modified code fragments.
- it takes a person who is a combination of a physicist, numerical analyst, and software developer to prototype new models, even if it involves only incremental changes to the source code. People with this mixture of skills are rare.
- any code with multiple developers at different sites will diverge into versions with different subsets of capabilities. Since it is desirable to have a single version with the union of the added capabilities, code merging must eventually be undertaken. Past experience indicates that a complete rewrite is often less effort than a merge.

The traditional approach to implementing models by hard-coding the discretized equations in a simulator is not viable in support to a rapid prototyping environment. A major change in the paradigm is needed.

The simulation environment must support discretized solutions of user-specified PDE-based models. This requirement means that the simulator must provide enough intelligence to map a PDE-based description into a discrete system of equations to be solved during simulation of the profile evolution. The discretization approach to be implemented (e.g. semidiscrete finite elements or box integration) will not be specified, but it is expected that the simulation environment will provide appropriate and robust spatial and temporal discretizations and include at least temporal error control, if not also spatial error control.

2.2 Mesh and wafer representation

Although a "wafer representation" is a critical building block for any process simulation tool, a large list of restrictive requirements is not necessary to support a rapid prototyping environment. Mesh and field representation requirements will be presented rather generically. There are only a few essential features needed to support portable model representation.

- The mesh is partitioned into a number of **regions** with each region supporting a homogeneous system of equations. The usual partitioning will likely be into **materials** and material **interfaces**. Regions are symbolically named, and the names provide a key in the model representation. To provide a more precise capability for selection of the region in which to apply a model, each instance of a material or interface region may also have an instance name associated with it.

- The mesh supports an arbitrary number of interpolated scalar quantities (**solutions**). These are also symbolically named, and the names provide a key into the model representation.

- All interpolated quantities are considered to be discontinuous across material interfaces (i.e. one value for each solution for each material at a point). Figure 1 shows a partitioning of a mesh into three regions. In this figure, there is one unique scalar solution value for each pair (a-b and c-d) of element's nodes on either side of the interface.

  There is a mechanism in the model description to specify continuity across an interface, when continuity is required for the model..

2.3 Other requirements

In addition to the mapping of the PDE-based description, a few additional capabilities are also needed. These include:

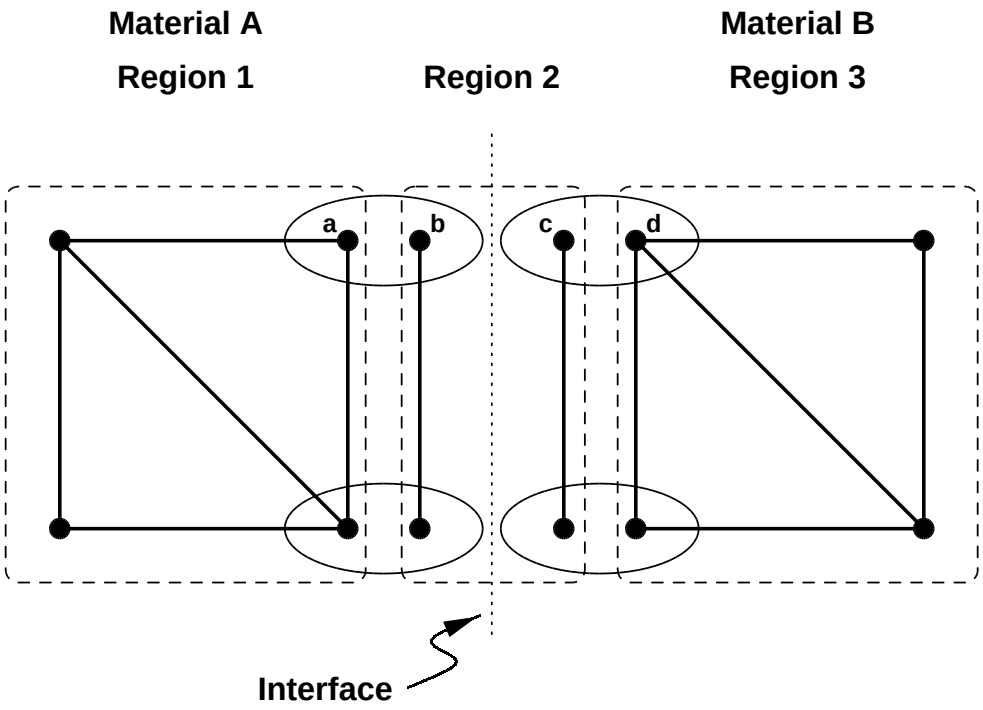

Figure 1: Partitioning of a mesh and representation of discontinuity at a boundary

- creation of solutions in the regions where they are needed and for the initialization of solution values.
- functionality to set up additional initial conditions that are not the result of a previous simulation step.
- availability of essential simulation parameters (e.g. processing temperature) to the model
- support for simulation of the model during processing that involves a moving boundary such as is encountered in simulating oxidation and salicidation as well as etch and deposition steps done at temperatures in which non-negligible movement of impurities may occur.

3 Model Representation: Dopant Diffusion Example

The "models" to be represented are multi-region, arbitrarily coupled systems of scalar PDEs. A scripting language will be used as a portable representation. Desired characteristics include:

1. dimensional independence

   The same model should be usable on a 1D, 2D, or 3D device structure.

2. hierarchical description of a model

   It should be possible to reference an existing model and add terms/equations to a model without respecifying the entire model.

3. mapping onto a specific device structure for simulation

   The semantics for mapping a model representation into a discretized system of equations should allow for the discarding of terms and equations related to unavailable solution variables, materials, and interfaces. This mapping includes creation and initialization of auxiliary solution variables as needed by the model.

4. portability

   The representation should not contain non-essential characteristics that tie its use to a particular simulation environment.

There are a few dial-an-operator[1] diffusion simulators that provide for specification of fairly arbitrary PDEs to be used as diffusion models (ALAMODE [5], DOPDEES [1], PEPPER [3], and PROPHET [4]). Each of these can represent and simulate general diffusion models within the limitations of the available terms in their "operator" libraries. Each supports specification at a script level as a multi-region, arbitrarily coupled systems of scalar PDEs. None of these has a native scripting representation that satisfies all of the above characteristics.

1. The ALAMODE and PROPHET model descriptions are dimensionally independent. DOPDEES and PEPPER only support 1D, and that is reflected in their model description syntax.

2. In DOPDEES, terms in the model can be added to equations anywhere in the model description, including across separate files. PROPHET's database has inheritance capabilities. The format of ALAMODE's native representation format doesn't support adding terms/equations to an existing model, but ALAMODE's scripting language (TCL) could be used to hierarchically build models. PEPPER's format doesn't support adding term/equations outside of the specification of a single model.

3. PROPHET rewrites models given available dopants and materials, eliminating terms for dopants and equations for material that are not present in the device structure to be simulated. ALAMODE ignores missing materials/interfaces, but can't handle missing dopants. PEPPER requires that the all materials and dopants in native model exist in the wafer structure.

   Both DOPDEES and ALAMODE have structure query mechanisms, and can produce a mapped model via their TCL front-ends based on the available fields, materials, and interfaces.

4. None of the native script representations are portable.

[1] ZOMBIE and PROMIS also support arbitrary diffusion models via user-supplied subroutines. Portability of their subroutine-based model descriptions to other simulators is not considered to be likely.

There is an effort under development to produce a format (Process Modeling Modules [2]) that can be shared by DOPDEES and ALAMODE. The present implementation reflects limitations from both DOPDEES and ALAMODE.

3.1 PDE components

For representation of the equation-based components, the information model shown by the entity-relationship (ER) diagram in Figure 2 is suggested. The ER diagram[2] shows that a diffusion **model** is composed of a list of **systems of equations** and, optionally, boundary conditions (**Dirichlet and/or continuity constraints**). Each **system of equations** composed of a list of **equation** to be applied in a **region**. Each **equation** is composed a sum of **terms**, and it solves for an interpolated **solution** variable. **Evaluables**, **parameters**, and **functions** provide the building blocks for **terms**.

Because **solutions** are assumed to be discontinuous at material interfaces, there needs to be a way to distinguish the values on either side of the interface. Adding a **material** key to the **solution** will uniquely identify values on either side of the interface. For references to **solutions** in bulk material regions, the **material** key is redundant, but the redundancy doesn't lead to any problems.

The components are defined as follows:

A **Parameter** is a named numeric constant that is spatially invariant. Parameters can be dependent on temperature, as long as temperature is constant over the device structure. Parameters can be dependent on time.

A **Solution** is the name of an interpolated field. It can be used as a solution variable for an equation.

A **Material** is the name of one of the bulk materials in which the **solution** exists.

A **Function** is a named spatially varying scalar quantity that is derived from a combination evaluables and parameters.

A **Term** is a discretized, linearly independent contribution to an equation, such as a diffusion term that takes a user-specified diffusivity and migrating species..

An **Equation** is a sum of terms. Each equation solves for a solution in a material. For bulk regions, the material is implied by the region. For interface regions, the material must be provided.

A **System Of Equations** is a coupled system of equations that will be applied in a specified region.

[2] In this diagram format, boxes indicate instances, and arrows indicate relationships between instances. The number of arrow heads indicates the order of the relationship ("to-one" or "to-many"). A "C" marks a relationship as conditional or optional.

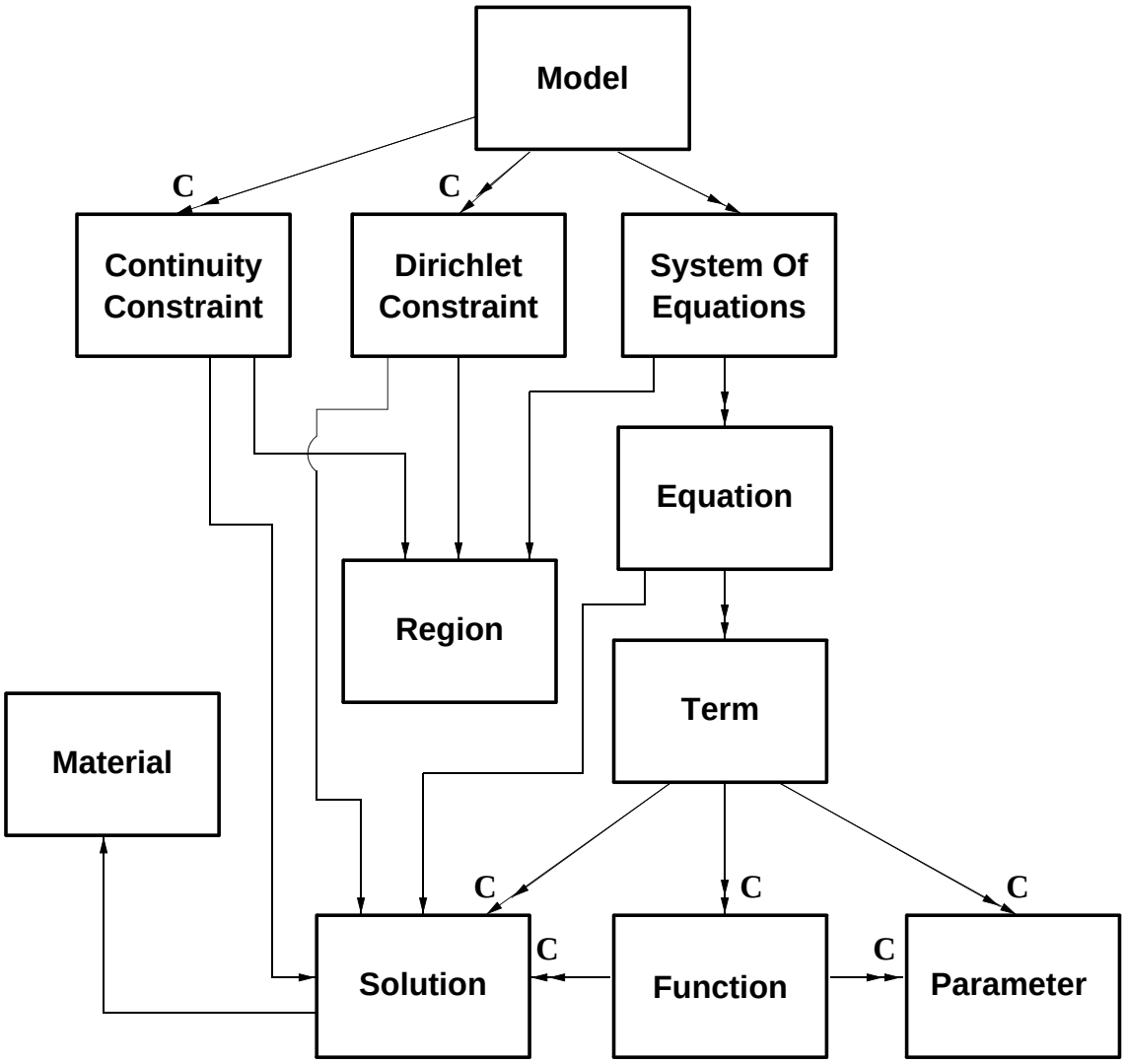

Figure 2: Entity-relationship diagram for a PDE-based model representation

A **Region** is the name of a subset of the discretized domain where the same **system of equations** will be solved.

A **Dirichlet Constraint** provides for specification of a Dirichlet boundary condition for a **solution** in an interface **region**.

A **Continuity Constraint** provides for ensuring continuity in a **solution** across an interface **region**.

A **Model** is the aggregation of **systems of equations** and optional boundary conditions.

Note that both bulk material regions and interface regions are treated homogeneously. This is a very

important characteristic. The information model does not differentiate between equations (or terms) that are in bulk materials or interfaces.

Although the ER diagram is useful for documenting the information model, it does not imply a unique scripting language representation. The "to-many" relationships from **term** is an ordered argument list, and it will have a fixed number of slots for each type of **term**. The "to-many" relationships from **function** represent a general algebraic expression, and this would ideally be described as an expression grammar. The remaining "to-many" relationships are unordered lists.

The acyclic structure of the ER diagram implies that an ordered (bottom-up) syntax can be used for construction of models. The various lists will be implicitly constructed, rather than explicitly enumerated, in order to best meet the desire for hierarchical description.

3.2 Script Components

The scripting language proposed here is an extension of TCL, and it provides for

- construction of the representation discussed in section 3.1
- semantics for mapping of a superset model into a reduced system of equations for simulation on a specific device structure via the `region/solution exists` query and TCL's built-in control structures. With this mapping procedure, the device structure must be available before the model script can be processed
- semantics for creation and initialization of auxiliary solutions needed by a model via the `solution create` command
- availability of simulation parameters (e.g. processing temperature) as predefined, standard parameters
- availability of externally computed simulation data (e.g. boundary velocities, post-processed stresses) necessary for computation of diffusion in structure with a concurrent oxidation simulation
- hierarchical construction of models via TCL's built-in `source` command
- portability by providing an alias mechanism for solution and material names

The additional TCL commands implementing the proposed script-based representation are given in the following sections.

3.2.1 alias

```
alias solution <name in model> <name in simulator>
alias material <name in model> <name in simulator>
```

The alias statement sets up a one-to-one global mapping between solution and material names used in the model description and those provided by the wafer representation database in a simulator.

The mappings provide for portability of the model description without specification of a standard set of names to be used for solutions (dopants, defects, clusters, etc.), and materials. Specifying a standard set of names would limit portability to the names in that set.

3.2.2 region

```
region exists <region name>[@<instance name>]
region current <region name>[@<instance name>]
```

If `exists` is specified, then the wafer database is queried. The return value is `"0"` (TCL false) if if the region does not exist and `"1"` (TCL true) if the region does exist.

If `current` is specified, the current region is set to to `<region name>`. The current region is needed to implicitly build up the lists of terms and equations. This must precede the first `parameter`, `solution`, `term`, or `function` statement.

If an `@<instance name>` is provided, then the following parameters, functions, and terms are only applied to the specified instance of that region, and any future region default region specifications will be ignored for that instance. Note that this does not imply that any parameters, functions, and terms added to the specified instance before the first occurrence of `region current` with the `@<instance name>` will be deleted. If the intent is that the region tagged with `@<instance name>` will have a unique model, the `@<instance name>` should be specified before any regions with the same `<region name>` .

The `<instance name>` is a non-portable feature that is intended only to aid integration with existing process simulators by avoiding the requirement of new material types for each region where the equations may be different. As an example of the intended use of `@<instance name>`, consider a SOI structure in which it is desired to use an advanced TED model in the isolated device structure and a simplified equilibrium model in the rest of the substrate. The `@<instance name>` provides the selection mechanism for deciding which model will be applied in the otherwise indistinguishable silicon material regions.

The `<region name>` should be the same as the `<material>` for bulk regions. For interface regions, it should be a concatenation of the two `<material>` names separated by a forward slash (/). The order of the two names is not important. MaterialA/MaterialB equivalent to MaterialB/MaterialA.

3.2.3 solution

```
solution exists <solution name>[@<material>]
solution dirichlet <solution name>[@<material>]
solution continuous <solution name>
solution create <solution name>[@<material>] <function tag>
```

If exists is specified, then the wafer database is queried. The return value is "0" (TCL false) if if the solution variable does not exist in the current region and "1" (TCL true) if the solution variable does exist.

The dirichlet and continuous options are used to set Dirichlet and continuity boundary conditions for the specified solution variable. The @<material> qualifier should not be given for continuity constraints in an interface region, but it should be specified for Dirichlet constraints, unless the interpolation values on both sides of the interface are fixed.

The create option specifies that the solution variable is to be created if it does not exist in the wafer representation. The function referenced by <function tag> is used to initialize the solution variable's values.

3.2.4 parameter

```
parameter defined <parameter tag>
parameter <parameter tag> {<parameter expression>}
```

If defined is specified, then this command returns "0" (TCL false) if the parameter has not been defined in this region and "1" if the parameter has been defined.

The parameter statement defines a parameter that can be used later in a model and provides an expression for evaluating it. The expression may include references to other parameters (including the predefined parameters, TEMP_K (temperature in Kelvin), TEMP_C (temperature in Celsius), TN, and DT, which reference the simulation temperature, time at the start of the integration interval, and time step for the integration interval, respectively). The expression is a C-style expression, limited to the following operators:

(...)	parenthetical grouping
literals	see below
f(...)	intrinsic function call
-	unary negation
* /	multiplicative
+ -	additive
¡ ¿ ¡= ¿=	relational
== !=	equality
? :	conditional

A literal is a numeric constant, a `<parameter tag>`, a TCL variable substitution (i.e. `$varname`), or a TCL command (e.g. `[expr ...]`) substitution. If a TCL substitution is present, it is evaluated once, at the time the parameter statement is processed and cannot reference other parameters.

The intrinsic function set is the same as those listed for the `function` statement minus the coordinate access functions.

Dependence on time and temperature is handled by the simulation environment, and parameters are reevaluated as needed using the supplied expression.

The numbers referenced as parameters will have an assumed unit set associated with them. The set of units must be self-consistent within the model and consistent with the discretization units in the simulation environment. For the simulation environment, the recommended standard for a set of units assumed for quantities supplied by the simulation environment is:

concentrations	cm^{-3}
time (including T and DT)	seconds
discretization length	cm
discretization time	seconds

The `<parameter tag>` name-space is per-region, not global.

3.2.5 `term`

`term <solution name>[@<material>] +/- <term name> [<arg> ...]`

This statement specifies a term to be added to the equation solving for `<solution name>[@<material>]` in the current region. The material need not be specified for bulk regions.

The +/- indicates whether the term should be added to or subtracted from the equation. For all equations, the sum of the terms equals zero.

A minimal set of terms and their arguments is listed below. Unless otherwise specified, each of the arguments can be a `<parameter tag>`, a `<function tag>`, or `<solution name>[@<material>]`.

`scalar <S>`

Adds the scalar quantity given by `<S>` to the equation.

`diffusion <D> <C>`

Adds a discretized diffusion term ($\nabla \cdot D\nabla C$) to the equation. `<D>` is the diffusivity, and `<C>` is the migrating species.

`drift <M> <P>`

Adds a discretized drift flux term to the equation. In typical diffusion models where the drift term is given by

$$\nabla \cdot Z_A \mu C_A \nabla \psi$$

`<M>` would lump the charge, mobility, and active concentration, and `<P>` would provide potential.

Although this operator looks equivalent to the `diffusion` operator, this separation allows for a stabilized discretization (e.g. via upwinding).

`d_dt` Adds a first order transient term to the equation. Only one first order transient term can be specified for each equation. Note, also, that this is not a general time derivative on a function. It can only be applied to the solution variable being solved for by this equation.

`outflux/influx` These are used to set the sign convention for interface flux constraints and can only be specified for interface equations. Only one of these or a `d_dt` term can be specified for an interface equation. The in or out convention is defined by the material specified for the solution variable being solved for.

3.2.6 `function`

`function <function tag> {<function expression>}`

The function statement defines a function named `<function tag>` which is evaluated by the given expression. The expression is a C-style expression, limited to the following operators:

(...)	parenthetical grouping
literals	see below
f(...)	intrinsic function call
-	unary negation
* /	multiplicative
+ -	additive
¡ ¿ ¡= ¿=	relational
== !=	equality
? :	conditional

A literal is a numeric constant, a `<parameter tag>`, a `<solution name>[@<material>]`, a `<function tag>`, a TCL variable substitution (i.e. `$varname`), or a TCL command (e.g. `[expr ...]`) substitution. If a TCL substitution is present, it is evaluated once, at the time the function statement is processed and cannot reference parameters or functions.

The required set of intrinsic functions is:

sqrt(x)	
log(x)	natural log
exp(x)	
pow(x,y)	x^y
abs(x)	absolute value
arcsinh(x)	inverse hyperbolic sine
erf(x)	error function
erfc(x)	complimentary error function
min(x,y)	
max(x,y)	
xcoord	x mesh coordinate
ycoord	y mesh coordinate
zcoord	z mesh coordinate
Arrhenius(pre,E)	

Implementations may provide intrinsic functions beyond those required here, but scripts that make use of those are not guaranteed to be portable among simulators.

The mesh coordinates returned have the default discretization units.

The `<function tag>` naming/access mechanism does not provide for function definitions with replaceable arguments.

3.3 Validation of conformance

To validate an implementation, a suite of TCL scripts should be developed to test all forms for each of the additional TCL commands as well as ensuring a correct implementation of expression syntax and availability of the required intrinsic functions. The expression validation tests can be performed using the `solution create` command.

Validation of the numerical discretizations can be performed by using models with known analytic solutions and measuring the error between the simulated results and the analytic solutions. Examples of test cases include a static homogeneous Poisson solve in 1D with Dirichlet boundary conditions or a transient linear diffusion simulation with an initial 1D Gaussian profile which would produce a Gaussian profile as the final result.

3.4 Other desirable simulation environment features

The emphasis in the preceding discussion has been to present sufficient descriptive capabilities to represent the PDE-based models required for simulation of orientation-independent "diffusion" processes in semiconductors. There is also a number of more pragmatic features that may still need to be considered.

3.4.1 Postprocessing

Many of the diffusion models will produce updated solution variables that are not immediately usable or even understood by other TCAD simulators, such as device simulators. Fixed model simulators know how to postprocess their fixed set of solution variables (e.g. active and chemical dopant concentrations) into a variable such as a net active concentration profile that a device simulator requires. The heuristics for postprocessing arbitrary solutions variables into a form that makes sense for another TCAD simulator are determined both by the semantics of the solution variables as calculated by the model and by the data input requirements of the next simulator in the chain. The latter makes it impossible to portably add postprocessing capabilities as part of the portable model description, but a capability similar to the `solution create` would be useful as a mechanism to provide postprocessing.

Another benefit from including some portable postprocessing is to help to meet validation needs, both validation of conformance of the environment as well as validation of model scripts. Profile extraction and plotting should be provided. The ability to compute integrated quantities (e.g. total integrated dose or the integral of an arbitrary function) are very useful for model validation.

3.4.2 Disabling model definition capabilities

The fact that end users can specify and/or change parameters, terms, and equations in the model may be unsettling to managers who only want a specific model and parameter set to be used for simulation. Fortunately, disabling these capabilities is trivial in TCL. Any TCL command can be disabled by redefining it at the script level. For example, `proc region {} {}` could be executed after the model definition phase to disable the `region` command.

References

[1] Alp H. Gencer. *Dial an Operator Partial Differential Equation Evaluator and Solver: User's Guide and Reference Manual*. Version 97.192.

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[4] Conor S. Rafferty and R. Kent Smith. Solving partial differential equations with the prophet simulator. Technical memorandum dated Dec. 2, 1996.

[5] Daniel W. Yergeau and Robert W. Dutton. *Alamode: A LAyered MOdel Developent Environment for simulation of impurity diffusion in semiconductors*. Version 97.06.18.